



Heisener.com

518-77-360M19-001106 Information

Part Number 518-77-360M19-001106

Manufacturer Preci-Dip

Category Connectors, Interconnects

Sockets for ICs, Transistors

Description CONN SOCKET PGA 360POS GOLD

Package -

For the pricing/inventory/lead time, please contact

us

For Reference Only Website: https://www.heisener.com

E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









518-77-360M19-001106 Specifications

Manufacturer Part Number	518-77-360M19-001106
Manufacturer	Preci-Dip
Category	Connectors, Interconnects
	Sockets for ICs, Transistors
Package	-
Series	518
Type	PGA
Number of Positions or Pins (Grid)	360 (19 x 19)
Pitch - Mating	0.050" (1.27mm)
Contact Finish - Mating	Gold
Contact Finish Thickness - Mating	Flash
Contact Material - Mating	Beryllium Copper
Mounting Type	Surface Mount
Features	Open Frame
Termination	Solder
Pitch - Post	0.050" (1.27mm)
Contact Finish - Post	Gold
Contact Finish Thickness - Post	Flash
Contact Material - Post	Brass
Housing Material	FR4 Epoxy Glass
Operating Temperature	-55°C ~ 125°C
	Report errors?

518-77-360M19-001106 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

518-77-360M19-001106 Payment Methods



















518-77-360M19-001106 Shipping Methods













If you have any question about 518-77-360M19-001106, please do not hesitate to contact us!

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